onsemi

<u>MOSFET</u> - Power, Single N-Channel 40 V, 0.7 mΩ, 378 A

NVMFS5C404N

Features

- Small Footprint (5x6 mm) for Compact Design
- Low R_{DS(on)} to Minimize Conduction Losses
- Low Q_G and Capacitance to Minimize Driver Losses
- NVMFS5C404NWF Wettable Flank Option for Enhanced Optical Inspection
- AEC-Q101 Qualified and PPAP Capable
- These Devices are Pb-Free and are RoHS Compliant

MAXIMUM RATINGS (T_J = 25°C unless otherwise noted)

Parameter			Symbol	Value	Unit	
Drain-to-Source Voltage			V _{DSS}	40	V	
Gate-to-Source Voltage			V _{GS}	±20	V	
Continuous Drain	Steady State	$T_C = 25^{\circ}C$	۱ _D	378	А	
Current R _{θJC} (Notes 1, 3)		T _C = 100°C		267		
Power Dissipation		$T_{C} = 25^{\circ}C$	PD	200	W	
R _{θJC} (Note 1)		$T_{C} = 100^{\circ}C$		100		
Continuous Drain		$T_A = 25^{\circ}C$	۱ _D	53	А	
Current R _{θJA} (Notes 1, 2, 3)	Steady State	$T_A = 100^{\circ}C$		37		
Power Dissipation		$T_A = 25^{\circ}C$	PD	3.9	W	
R _{θJA} (Notes 1, 2)		$T_A = 100^{\circ}C$		1.9		
Pulsed Drain Current	$T_A = 25^{\circ}C$, $t_p = 10 \ \mu s$		I _{DM}	900	А	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	–55 to +175	°C	
Source Current (Body Diode)			۱ _S	191	А	
Single Pulse Drain-to-Source Avalanche Energy (I _{L(pk)} = 38 A)			E _{AS}	907	mJ	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)			ΤL	260	°C	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL RESISTANCE MAXIMUM RATINGS

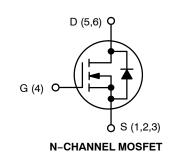
Parameter	Symbol	Value	Unit
Junction-to-Case - Steady State	$R_{\theta JC}$	0.75	°C/W
Junction-to-Ambient - Steady State (Note 2)	$R_{\theta JA}$	39	

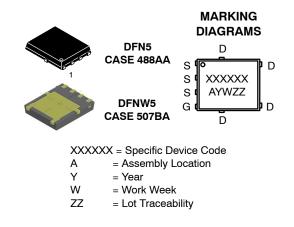
1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Surface-mounted on FR4 board using a 650 mm², 2 oz. Cu pad.

Maximum current for pulses as long as 1 second is higher but is dependent on pulse duration and duty cycle.

V _{(BR)DSS}	R _{DS(ON)} MAX	I _D MAX		
40 V	$0.7~\mathrm{m}\Omega @~10~\mathrm{V}$	378 A		





ORDERING INFORMATION

See detailed ordering, marking and shipping information on page 5 of this data sheet.

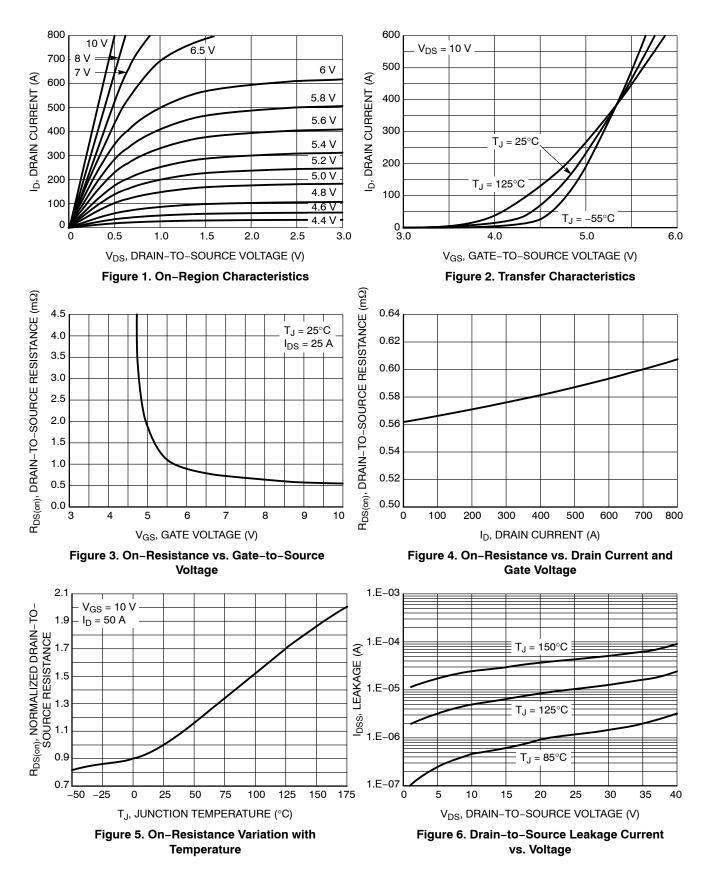
ELECTRICAL CHARACTERISTICS (T_J = $25^{\circ}C$ unless otherwise specified)

Parameter	Symbol	Test Condition		Min	Тур	Max	Unit
OFF CHARACTERISTICS	<u> </u>						
Drain-to-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0 V, I_D = 250 μ A		40			V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V _{(BR)DSS} / T _J				19.7		mV/°C
Zero Gate Voltage Drain Current	I _{DSS}	$ \begin{array}{c} V_{GS} = 0 \ V, \\ V_{DS} = 40 \ V \end{array} \qquad \begin{array}{c} T_{J} = 25 \ ^{\circ}C \\ T_{J} = 125 \ ^{\circ}C \end{array} $				10	
						250	μA
Gate-to-Source Leakage Current	I _{GSS}	V_{DS} = 0 V, V_{Gi}	_S = 20 V			100	nA
ON CHARACTERISTICS (Note 4)							
Gate Threshold Voltage	V _{GS(TH)}	$V_{GS} = V_{DS}, I_D$	= 250 μA	2.0		4.0	V
Threshold Temperature Coefficient	V _{GS(TH)} /T _J				-6.2		mV/°C
Drain-to-Source On Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 50 A		0.57	0.7	mΩ
Forward Transconductance	9 _{FS}	V _{DS} =15 V, I _E	₀ = 50 A		210		S
CHARGES, CAPACITANCES & GATE RE	SISTANCE						
Input Capacitance	C _{ISS}	V _{GS} = 0 V, f = 1 MHz, V _{DS} = 25 V			8400		pF
Output Capacitance	C _{OSS}				4600		
Reverse Transfer Capacitance	C _{RSS}				120		
Total Gate Charge	Q _{G(TOT)}	V_{GS} = 10 V, V_{DS} = 20 V; I_D = 50 A			128		
Threshold Gate Charge	Q _{G(TH)}	V _{GS} = 10 V, V _{DS} = 20 V; I _D = 50 A			22		nC
Gate-to-Source Charge	Q _{GS}				35		
Gate-to-Drain Charge	Q _{GD}				26		
Plateau Voltage	V _{GP}				4.3		V
SWITCHING CHARACTERISTICS (Note 5	5)						
Turn-On Delay Time	t _{d(ON)}	V_{GS} = 10 V, V_{DS} = 20 V, I _D = 50 A, R _G = 2.5 Ω			16		
Rise Time	tr				113		ns
Turn-Off Delay Time	t _{d(OFF)}				77		
Fall Time	t _f				109		
DRAIN-SOURCE DIODE CHARACTERIS	TICS						
Forward Diode Voltage	V _{SD}	V _{GS} = 0 V,	$T_J = 25^{\circ}C$		0.76	1.2	
		T _J = 125°C		0.63		V	
Reverse Recovery Time	t _{RR}	V _{GS} = 0 V, dIS/dt = 100 A/µs, I _S = 50 A			96		
Charge Time	ta				49		ns
Discharge Time	t _b				47		
Reverse Recovery Charge	Q _{RR}				189		nC

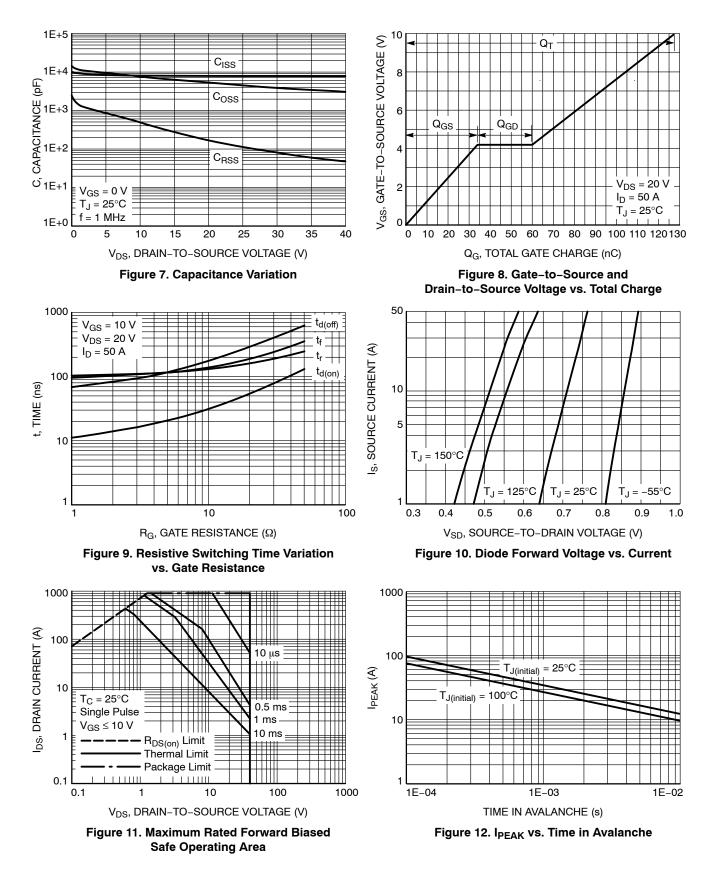
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 4. Pulse Test: pulse width $\leq 300 \ \mu$ s, duty cycle $\leq 2\%$.

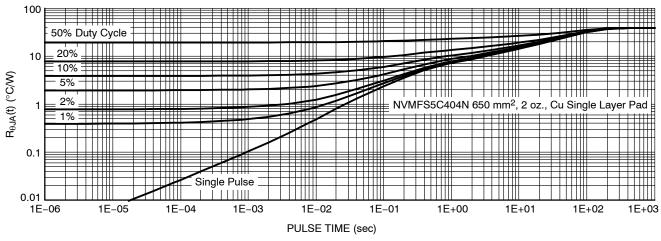
5. Switching characteristics are independent of operating junction temperatures.

TYPICAL CHARACTERISTICS



TYPICAL CHARACTERISTICS







DEVICE ORDERING INFORMATION

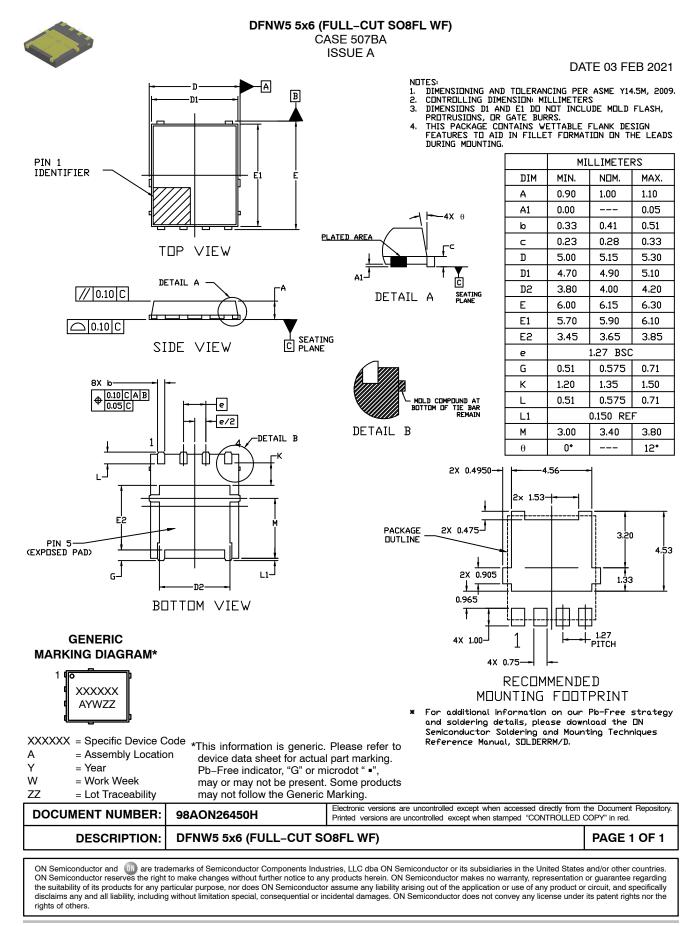
Device	Case	Marking	Package	Shipping [†]
NVMFS5C404NT1G	488AA	5C404N	DFN5 (Pb-Free)	1500 / Tape & Reel
NVMFS5C404NWFT1G	488A	404NWF	DFN5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel
NVMFS5C404NT3G	488AA	5C404N	DFN5 (Pb–Free)	5000 / Tape & Reel
NVMFS5C404NWFT3G	488AA	404NWF	DFN5 (Pb-Free, Wettable Flanks)	5000 / Tape & Reel
NVMFS5C404NAFT1G	488AA	5C404N	DFN5 (Pb–Free)	1500 / Tape & Reel
NVMFS5C404NWFAFT1G	488AA	404NWF	DFN5 (Pb-Free, Wettable Flanks)	1500 / Tape & Reel
NVMFS5C404NWFET1G	507BA	404NWF	DFN5W (Pb-Free, Wettable Flanks)	1500 / Tape & Reel
NVMFS5C404NWFET3G	507BA	404NWF	DFN5W (Pb-Free, Wettable Flanks)	5000 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.









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